

Item no.: 333837 RE-UP-CHT01-A20-0216-FACE01 - Riddletag Face Recognition 3D Kit



Item no.: 333837 shipping weight: 1.40 kg Manufacturer: UP Bridge the Gap



Product Description

RE-UP-CHT01-A20-0216-FACE01 - Riddletag Face Recognition 3D Kit

The Riddletag Face Recognition 3D Kit is aiming to speed up a face recognition project by providing all hardware and software in one.

All the parts are integrated with Riddletag Face Analysis software and Facecard Cloud (with an option to integrate with your own cloud). The solution can be rapidly embedded into an existing hardware infrastructure within different vertical markets.

The kit includes UP board, RealSense camera, and Riddletag 3D Face Analysis Application running on the edge and a trial plan of Riddletag Facecard Cloud Face Recognition Service* in the Cloud.

*Riddletag Facecard Cloud Face Recognition Service provides: 500 API requests**, number of 100 users in database

**API request is used to get a resource from cloud service (e.g. request to add users in database, request to do face matching, etc.) Basic info

- Part number: RE-UP-CHT01-A20-0216-FACE01
- Mainboard: UP board
 Availability: Active

System level spec

- SoC: Intel(R) Atom(TM) x5-z8350 (up to 1.92 GHz)
- # of cores: 4
- Graphics: Intel(R) HD 400 Graphics
 FPGA: Intel(R) FPGA Altera Max V

- Memory: 2 GB
 eMMC: 16 GB
 BIOS: UEFI
- RTC: Yes
- Wake on LAN (WoL): Yes •
- Watchdog timer: Yes
 PXE: Yes
- Compatible OS: Ubuntu server 18.04.4
 Power requirement: 5 V DC-in (at) 4 A, 5.5/2.1 mm jack
 Power supply type: AT (default)/ATX

- Power consumption (typical): 13 Watt
 Dimensions: 3.37x 2.22 (85.6 mm x 56.5 mm)
- MTBF (hours): 270,599

Display

• HDMI: 1x (HDMI 1.4a)

I/O

- Audio: I2S audio port
 USB 2.0 type A: 4x
 USB 2.0 pin header: 2x
 USB 3.0 OTG Micro B: 1x
 UART: 2x UART (Tx/Rx) debug port (pin header)
 40-pin GP bus: 1
 MIPI-CSI: 1x MIPI-CSI 2 lane
 SIM slot: No

Connectivity

- Ethernet: 1x GbLAN (RealTek RTL8111H-CG)
 Wi-Fi: Optional Wi-Fi 802.11 b/g/n (at) 2.4 GHz (Fangtec-GWF-7M02)
 Bluetooth: Optional Bluetooth V4.0
 LTE/4G: N/A

Cooling

• Cooling: Passive cooling (fanless)

Environment

Operation temperature: 32°F ~ 140°F (0°C ~ 60°C)
Storage temperature: -40°F ~ 176°F (-40°C ~ 80°C)

Longevity

Longevity: 2024

Specifications

Scan this QR code to view the product All details, up-to-date prices and availability

